

August 2003



SEMICONDUCTOR

# FGH60N6S2

# 600V, SMPS II Series N-Channel IGBT

## General Description

The FGH60N6S2 is a Low Gate Charge, Low Plateau Voltage SMPS II IGBT combining the fast switching speed of the SMPS IGBTs along with lower gate charge and plateau voltage and avalanche capability (UIS). These LGC devices shorten delay times, and reduce the power requirement of the gate drive. These devices are ideally suited for high voltage switched mode power supply applications where low conduction loss, fast switching times and UIS capability are essential. SMPS II LGC devices have been specially designed for:

- Power Factor Correction (PFC) circuits
- Full bridge topologies
- Half bridge topologies
- Push-Pull circuits
- Uninterruptible power supplies

Zero voltage and zero current switching circuits

### Formerly Developmental Type TA49346.

## Features

- 100kHz Operation at 390V, 52A
- 200kHZ Operation at 390V, 31A
- 600V Switching SOA Capability
- Typical Fall Time......77ns at TJ = 125°C
- Low Gate Charge ..... 140nC at V<sub>GE</sub> = 15V
- Low Plateau Voltage .....6.5V Typical
- Low Conduction Loss

| ackage                          | TO-247 E<br>G<br>COLLECTOR<br>(Back-Metal)                                |               |  |  |
|---------------------------------|---|---------------|--|--|
| evice N                         | <b>laximum Ratings</b> T <sub>C</sub> = 25°C unless otherwise noted       |               |  |  |
| e <mark>vice N</mark><br>Symbol | Iaximum Ratings T <sub>C</sub> = 25°C unless otherwise noted<br>Parameter | Ratings Units |  |  |
|                                 |   | Ratings Units |  |  |
| Symbol                          | Parameter   |               |  |  |

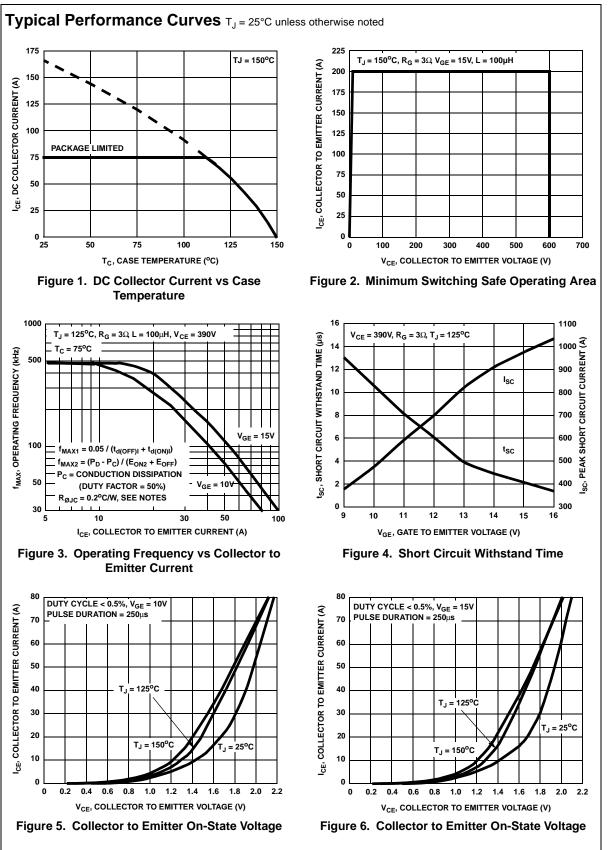
| 'C25              | Solicetor Surrent Continuous, 1C = 25 C  | 15           | ~    |
|-------------------|--|--------------|------|
| I <sub>C110</sub> | Collector Current Continuous, T <sub>C</sub> = 110°C                             | 75           | А    |
| I <sub>CM</sub>   | Collector Current Pulsed (Note 1)  | 320          | А    |
| V <sub>GES</sub>  | Gate to Emitter Voltage Continuous   | ±20          | V    |
| V <sub>GEM</sub>  | Gate to Emitter Voltage Pulsed   | ±30          | V    |
| SSOA              | Switching Safe Operating Area at $T_J = 150^{\circ}$ C, Figure 2                 | 200A at 600V |      |
| E <sub>AS</sub>   | Pulsed Avalanche Energy, I <sub>CE</sub> = 20A, L = 1.3mH, V <sub>DD</sub> = 50V | 700          | mJ   |
| PD                | Power Dissipation Total T <sub>C</sub> = 25°C                                    | 625          | W    |
| 2 200             | Power Dissipation Derating T <sub>C</sub> > 25°C                                 | 5            | W/°C |
| Τ <sub>J</sub>    | Operating Junction Temperature Range   | -55 to 150   | °C   |
| T <sub>STG</sub>  | Storage Junction Temperature Range   | -55 to 150   | °C   |
|                   |  |              |      |

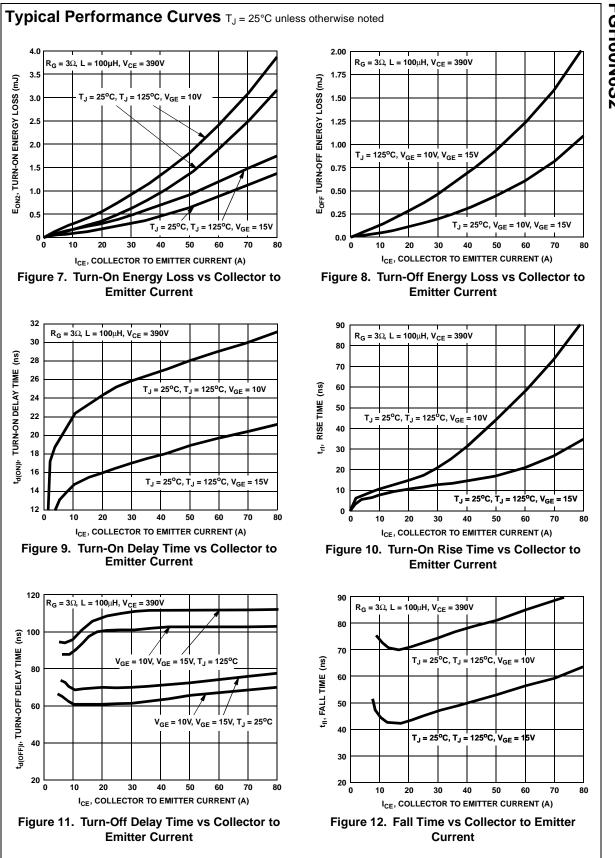
CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. NOTE:

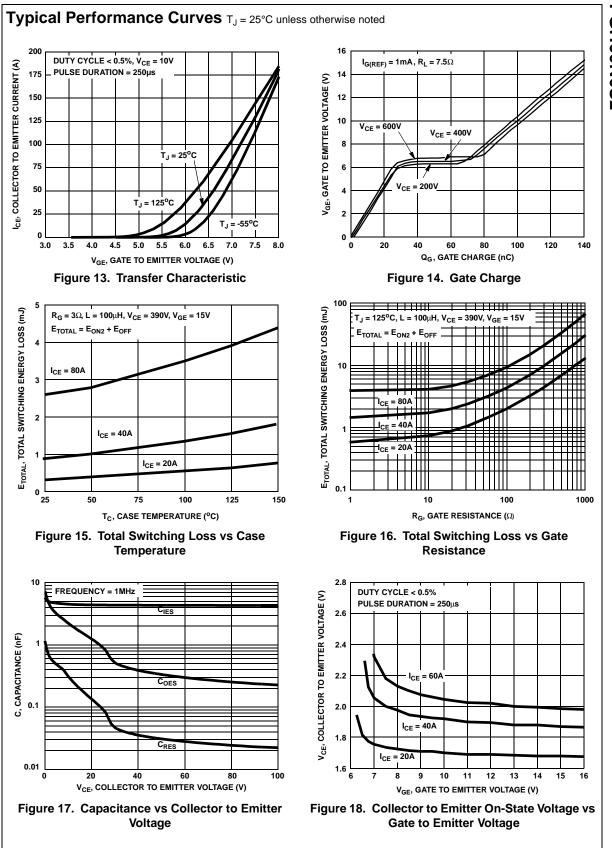
Pulse width limited by maximum junction temperature.

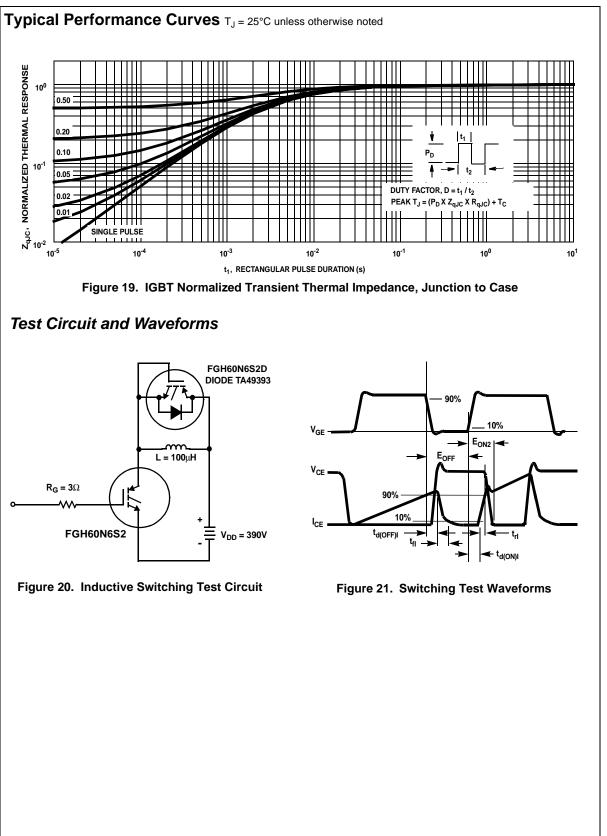
| Device Marking         Device           60N6S2         FGH60N6S2   |   | Pac  | kage   | Reel Size   | Тар   | Tape Width  |   | antity  |  |
|--|---|--|--|---|---|---|---|---|--|
|  |   | TO-  | -247   | Tube  |   | N/A   |   | 30  |  |
| ectric   | al Char   | acteristics T <sub>J</sub> = 25°C  | unless   | otherwise   | noted   |   |   |   |  |
| Symbol   |   | Parameter  |  | Test Co   | onditions   | Min   | Тур   | Max   | Units  |
| if State   | Characte  | eristics   |  |   |   |   |   |   |  |
| BV <sub>CES</sub>  |   |  | ge I <sub>C</sub> :  | $I_{C} = 250 \mu A, V_{GE} = 0$   |   | 600   | -   | -   | V  |
| BV <sub>ECS</sub>  | Emitter to  | Collector Breakdown Volta  | ge I <sub>C</sub> :  | $I_{C} = -10 \text{mA}, V_{GE} = 0$   |   | 20  | -   | -   | V  |
| ICES   | Collector   | to Emitter Leakage Current   | V <sub>C</sub>   | $V_{CE} = 600V$ $T_{J} = 25^{\circ}C$   |   | -   | -   | 250   | μA   |
|  |   |  |  |   | T <sub>J</sub> = 125°C  | -   | -   | 3   | mA   |
| I <sub>GES</sub>   | GES Gate to Emitter Leakage Current   |  | V <sub>G</sub>   | <sub>BE</sub> = ± 20V   |   | -   | -   | ±250  | nA   |
| n State  | Characte  | eristics   |  |   |   |   |   |   |  |
| V <sub>CE(SAT)</sub>   |   | Collector to Emitter Saturation Voltage  |  | I <sub>C</sub> = 40A,   | $T_J = 25^{\circ}C$   | -   | 1.9   | 2.5   | V  |
|  |   |  | V <sub>G</sub>   | <sub>SE</sub> = 15V   | T <sub>J</sub> = 125°C  | -   | 1.65  | 2.2   | V  |
| namic  | Characte  | eristics   |  |   |   |   |   |   |  |
| Q <sub>G(ON)</sub>   | Gate Cha  |  |  | = 40A,  | V <sub>GE</sub> = 15V   | -   | 140   | 175   | nC   |
| ∽G(ON)   | eate ent  |  | V <sub>C</sub>   | <sub>E</sub> = 300V   | $V_{GE} = 20V$  | -   | 180   | 225   | nC   |
| V <sub>GE(TH)</sub>  | Gate to E   | mitter Threshold Voltage   |  | = 250µA, V  |   | 3.5   | 4.3   | 5.0   | V  |
| V <sub>GEP</sub>   | -   | mitter Plateau Voltage   |  | = 40A, V <sub>CE</sub>  |   | -   | 6.5   | 8.0   | V  |
|  |   | teristics  | <u>i</u>   |   |   | 1   | -i  | i   | <del>.</del>   |
| SSOA   | Switching   |  |  |   | <sub>G</sub> = 3Ω, V <sub>GE</sub> =<br>H, V <sub>CE</sub> = 600V                                     | 200   | -   | -   | A  |
| -  | Switching   |  | 15V  | /, L = 100μ⊢  | $S_{G} = 3\Omega, V_{GE} =$<br>H, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,              | 200   | - 18  | -   | A  |
| SSOA   | Switching<br>Current T  | ) SOA  | 15V<br>IGB   | /, L = 100μ⊢<br>T and Diod<br>= 40A,  | H, V <sub>CE</sub> = 600V   |   | -<br>18<br>15   | -   |  |
| SSOA   | Switching<br>Current T<br>Current R   | g SOA<br>Turn-On Delay Time  | 15V<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub>   | /, L = 100μH<br>BT and Diod<br>= 40A,<br><sub>E</sub> = 390V,   | H, V <sub>CE</sub> = 600V   | -   | -   |   | ns   |
| SSOA<br>t <sub>d(ON)I</sub><br>t <sub>rl</sub>   | Switching<br>Current T<br>Current R   | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time  | 15V<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub><br>V <sub>GE</sub>  | /, L = 100µH<br>BT and Diod<br>= 40A,<br>= = 390V,<br>= = 15V,  | H, V <sub>CE</sub> = 600V   | -   | 15  | -   | ns<br>ns   |
| SSOA<br>t <sub>d(ON)I</sub><br>t <sub>rI</sub><br>t <sub>d(OFF)I</sub>   | Switching<br>Current T<br>Current R<br>Current T<br>Current F   | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time  | 15V<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub><br>V <sub>CE</sub><br>R <sub>G</sub>  | /, L = 100μH<br>BT and Diod<br>= 40A,<br><sub>E</sub> = 390V,   | H, V <sub>CE</sub> = 600V   | -   | 15<br>70  | -   | ns<br>ns<br>ns   |
| SSOA<br>t <sub>d(ON)I</sub><br>t <sub>rI</sub><br>t <sub>d(OFF)I</sub><br>t <sub>fI</sub>  | Switching<br>Current T<br>Current F<br>Current T<br>Current F<br>Turn-On I  | y SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Fall Time   | 15V<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub><br>V <sub>GE</sub><br>R <sub>G</sub>  | $V_{\rm t}$ L = 100 $\mu$ F<br>FT and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$   | I, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,   | -<br>-<br>-<br>-  | 15<br>70<br>50  |   | ns<br>ns<br>ns<br>ns   |
| $\frac{t_{d(ON)I}}{t_{rI}}$ $\frac{t_{d(OFF)I}}{t_{fI}}$ $E_{ON1}$   | Switching<br>Current T<br>Current R<br>Current T<br>Current F<br>Turn-On I<br>Turn-On I   | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Fall Time<br>Energy (Note 2)  | 15V<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub><br>V <sub>GE</sub><br>R <sub>G</sub>  | $X_{1} L = 100 \mu F$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 \mu H   | I, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,   | -<br>-<br>-<br>-  | 15<br>70<br>50<br>400   | -   | ns<br>ns<br>ns<br>ns<br>μJ   |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \end{array}$  | Switching<br>Current T<br>Current F<br>Current T<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-Off   | g SOA<br>Furn-On Delay Time<br>Rise Time<br>Furn-Off Delay Time<br>Fall Time<br>Energy (Note 2)<br>Energy (Note 2)   | 15V<br>IGB<br>I <sub>CE</sub> :<br>V <sub>CE</sub><br>V <sub>GE</sub><br>L =<br>Test   | $X_{1} L = 100 \mu F$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3Ω<br>100 µ H<br>t Circuit - F  | I, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,   | -<br>-<br>-<br>-<br>-<br>-  | 15<br>70<br>50<br>400<br>490  | -<br>-<br>-<br>-<br>-                                   | ns<br>ns<br>ns<br>ns<br>μJ<br>μJ                                     |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \end{array}$  | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-Of I<br>Current T   | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Tall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)  | 15V<br>IGB<br>I <sub>CE</sub> <sup>2</sup><br>V <sub>CE</sub><br>V <sub>GE</sub><br>R <sub>G</sub> <sup>2</sup><br>L =<br>Test<br>IGB  | $f_{1} L = 100 \mu F_{1}$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F  | l, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20                                 | -<br>-<br>-<br>-<br>-<br>-  | 15<br>70<br>50<br>400<br>490<br>310   | -<br>-<br>-<br>-<br>450                                 | ns<br>ns<br>ns<br>ms<br>µJ<br>µJ                                     |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)1} \\ \hline t_{r1} \\ \hline t_{d(OFF)1} \\ \hline t_{f1} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)1} \\ \hline t_{r1} \\ \end{array}$   | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Off I<br>Current T<br>Current F  | g SOA<br>Furn-On Delay Time<br>Rise Time<br>Furn-Off Delay Time<br>Fall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Furn-On Delay Time  | 15V<br>IGB<br>V <sub>CE</sub><br>V <sub>GE</sub><br>R <sub>G</sub><br>L =<br>Test<br>IGB<br>I <sub>CE</sub><br>V <sub>CE</sub>   | $f_{1} L = 100 \mu F_{1}$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,   | l, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20                                 | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-   | 15<br>70<br>50<br>400<br>490<br>310<br>27   | -<br>-<br>-<br>-<br>450<br>-                            | ns<br>ns<br>ns<br>μJ<br>μJ<br>μJ<br>ns                               |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)I} \\ \hline \end{array}$   | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Off I<br>Current T<br>Current F  | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Tall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time  | 15V<br>IGB<br>V <sub>CE</sub><br>V <sub>GE</sub><br>R <sub>G</sub> :<br>L =<br>Test<br>IGB<br>I <sub>CE</sub> :<br>V <sub>CE</sub><br>V <sub>CE</sub>  | $f_{1} L = 100 \mu F_{1}$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3Ω<br>100 µ H<br>t Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,   | l, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20                                 | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-   | 15           70           50           400           490           310           27           32  | -<br>-<br>-<br>-<br>-<br>450<br>-<br>-                  | ns<br>ns<br>ns<br>μJ<br>μJ<br>μJ<br>ns<br>ns                         |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline \end{array}$  | Switching<br>Current T<br>Current R<br>Current T<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-Of I<br>Current T<br>Current R<br>Current T   | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Tall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time  | 15V           IGB           Ice           Vce           Vce           Rg           L =           Test           IGB           Ice           Vce           Vce           Rg           Vce           Vce           Vce           Vce           Vce           Vce           Vce           Vce       | $f_{1} L = 100 \mu F_{1}$<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,   | l, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20                                 | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 15           70           50           400           490           310           27           32           110                            | -<br>-<br>-<br>450<br>-<br>-<br>-<br>150                | ns<br>ns<br>ns<br>μJ<br>μJ<br>μJ<br>ns<br>ns<br>ns                   |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)1} \\ \hline t_{r1} \\ \hline t_{d(OFF)1} \\ \hline t_{f1} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)1} \\ \hline t_{r1} \\ \hline t_{d(OFF)1} \\ \hline t_{f1} \\ \hline \end{array}$   | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Off<br>Current T<br>Current F<br>Current F<br>Turn-On I  | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Fall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Fall Time   | 15V           IGB           Ice           Vce           Vce           Rg           L =           Test           IGB           Ice           Vce           Rg           Ice           Vce           Vce           Vce           Vce           Vce           Vce           L =                     | $X_{\rm L} = 100\mu$ F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>Circuit - F<br>Circuit - F<br>Circuit - F<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$ | H, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20<br>le at T <sub>J</sub> = 125°C | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 15           70           50           400           310           27           32           110           77                             | -<br>-<br>-<br>-<br>450<br>-<br>-<br>-<br>150<br>90     | ns<br>ns<br>ns<br>μJ<br>μJ<br>μJ<br>ns<br>ns<br>ns<br>ns             |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline \end{array}$                                     | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Of I<br>Current T<br>Current F<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-On I               | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Time<br>Energy (Note 2)  | 15V           IGB           Ice           Vce           Vce           Rg           L =           Test           IGB           Ice           Vce           Rg           Ice           Vce           Vce           Vce           Vce           Vce           Vce           L =                     | $X_{\rm L} = 100\mu$ F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H  | H, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20<br>le at T <sub>J</sub> = 125°C | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 15           70           50           400           490           310           27           32           110           77           400 | -<br>-<br>-<br>450<br>-<br>-<br>-<br>150<br>90<br>450   | ns<br>ns<br>ns<br>ns<br>μJ<br>μJ<br>ns<br>ns<br>ns<br>ns<br>ns       |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline \end{array}$ | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Of I<br>Current T<br>Current F<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-On I               | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Tall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time | 15V           IGB           Ice           Vce           Vce           Rg           L =           Test           IGB           Ice           Vce           Rg           Ice           Vce           Vce           Vce           Vce           Vce           Vce           L =                     | $X_{\rm L} = 100\mu$ F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H  | H, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20<br>le at T <sub>J</sub> = 125°C | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 15           70           50           400           310           27           32           110           77           400           750 | -<br>-<br>-<br>450<br>-<br>-<br>150<br>90<br>450<br>850 | ns<br>ns<br>ns<br>μJ<br>μJ<br>ns<br>ns<br>ns<br>ns<br>ns<br>μJ       |
| $\begin{array}{c} \text{SSOA} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline t_{d(ON)I} \\ \hline t_{rI} \\ \hline t_{d(OFF)I} \\ \hline t_{fI} \\ \hline E_{ON1} \\ \hline E_{ON2} \\ \hline E_{OFF} \\ \hline \end{array}$ | Switching<br>Current T<br>Current F<br>Current F<br>Current F<br>Turn-On I<br>Turn-Off I<br>Current T<br>Current F<br>Current T<br>Current F<br>Turn-On I<br>Turn-On I<br>Turn-On I | g SOA<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time<br>Tall Time<br>Energy (Note 2)<br>Energy (Note 2)<br>Energy (Note 3)<br>Turn-On Delay Time<br>Rise Time<br>Turn-Off Delay Time | 15V           IGB           Ice :           Vce           VGE           RG :           IGB           Ice :           Vce           Vce           Vce           Vce           VGE           Vce           Vce           Vce           Vce           Vce           Vce           Vce           Vce | $X_{\rm L} = 100\mu$ F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H<br>t Circuit - F<br>Circuit - F<br>T and Diod<br>= 40A,<br>= 390V,<br>= 15V,<br>= 3 $\Omega$<br>100 $\mu$ H  | H, V <sub>CE</sub> = 600V<br>le at T <sub>J</sub> = 25°C,<br>igure 20<br>le at T <sub>J</sub> = 125°C | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 15           70           50           400           310           27           32           110           77           400           750 | -<br>-<br>-<br>450<br>-<br>-<br>150<br>90<br>450<br>850 | ns<br>ns<br>ns<br>μJ<br>μJ<br>μJ<br>ns<br>ns<br>ns<br>ns<br>ns<br>μJ |

3. Turn-Off Energy Loss (E<sub>OFF</sub>) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero ( $I_{CE} = 0A$ ). All devices were tested per JEDEC Standard No. 24-1 Method for Measurement of Power Device Turn-Off Switching Loss. This test method produces the true total Turn-Off Energy Loss.









## Handling Precautions for IGBTs

Insulated Gate Bipolar Transistors are susceptible to gate-insulation damage by the electrostatic discharge of energy through the devices. When handling these devices, care should be exercised to assure that the static charge built in the handler's body capacitance is not discharged through the device. With proper handling and application procedures, however, IGBTs are currently being extensively used in production by numerous equipment manufacturers in military, industrial and consumer applications, with virtually no damage problems due to electrostatic discharge. IGBTs can be handled safely if the following basic precautions are taken:

- Prior to assembly into a circuit, all leads should be kept shorted together either by the use of metal shorting springs or by the insertion into conductive material such as "ECCOSORBD™ LD26" or equivalent.
- 2. When devices are removed by hand from their carriers, the hand being used should be grounded by any suitable means for example, with a metallic wristband.
- 3. Tips of soldering irons should be grounded.
- 4. Devices should never be inserted into or removed from circuits with power on.
- Gate Voltage Rating Never exceed the gatevoltage rating of V<sub>GEM</sub>. Exceeding the rated V<sub>GE</sub> can result in permanent damage to the oxide layer in the gate region.
- Gate Termination The gates of these devices are essentially capacitors. Circuits that leave the gate open-circuited or floating should be avoided. These conditions can result in turn-on of the device due to voltage buildup on the input capacitor due to leakage currents or pickup.
- 7. Gate Protection These devices do not have an internal monolithic Zener diode from gate to emitter. If gate protection is required an external Zener is recommended.

## **Operating Frequency Information**

Operating frequency information for a typical device (Figure 3) is presented as a guide for estimating device performance for a specific application. Other typical frequency vs collector current ( $I_{CE}$ ) plots are possible using the information shown for a typical unit in Figures 5, 6, 7, 8, 9 and 11. The operating frequency plot (Figure 3) of a typical device shows  $f_{MAX1}$  or  $f_{MAX2}$ : whichever is smaller at each point. The information is based on measurements of a typical device and is bounded by the maximum rated junction temperature.

 $f_{MAX1}$  is defined by  $f_{MAX1} = 0.05/(t_{d(OFF)I} + t_{d(ON)I})$ . Deadtime (the denominator) has been arbitrarily held to 10% of the on-state time for a 50% duty factor. Other definitions are possible.  $t_{d(OFF)I}$  and  $t_{d(ON)I}$  are defined in Figure 27. Device turn-off delay can establish an additional frequency limiting condition for an application other than  $T_{JM}$ .  $t_{d(OFF)I}$  is important when controlling output ripple under a lightly loaded condition.

 $f_{MAX2}$  is defined by  $f_{MAX2} = (P_D - P_C)/(E_{OFF} + E_{ON2})$ . The allowable dissipation  $(P_D)$  is defined by  $P_D = (T_{JM} - T_C)/R_{\theta JC}$ . The sum of device switching and conduction losses must not exceed  $P_D$ . A 50% duty factor was used (Figure 3) and the conduction losses  $(P_C)$  are approximated by  $P_C = (V_{CE} \times I_{CE})/2$ .

 $E_{ON2}$  and  $E_{OFF}$  are defined in the switching waveforms shown in Figure 27.  $E_{ON2}$  is the integral of the instantaneous power loss ( $I_{CE} \times V_{CE}$ ) during turn-on and  $E_{OFF}$  is the integral of the instantaneous power loss ( $I_{CE} \times V_{CE}$ ) during turn-off. All tail losses are included in the calculation for  $E_{OFF}$ ; i.e., the collector current equals zero ( $I_{CE} = 0$ )

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